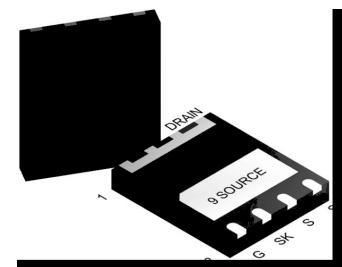


GaN Enhancement-mode Power Transistor

Features

- Enhancement-mode transistor - normally-OFF power switch
- Ultra-high switching frequency
- No reverse-recovery charge
- Low gate charge, low output charge
- Qualified for industrial applications according to JEDEC standards
- ESD safeguard
- RoHS, Pb-free

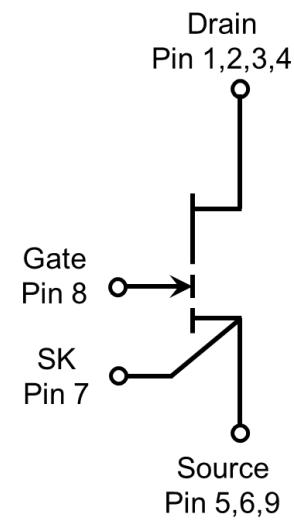


Applications

- AC-DC converters
- DC-DC converters
- Totem pole PFC
- Fast battery charging
- High-density power conversion
- High-efficiency power conversion

Table 1 Key Performance Parameters at $T_j = 25^\circ\text{C}$

Parameters	Values	Units
$V_{DS, \text{max}}$	650	V
$R_{DS(\text{on}), \text{max}}$	480	mΩ
$Q_{G, \text{typ}}$	1.2	nC
I_D, Pulse	9	A
$Q_{oss} @ 400 \text{ V}$	9.9	nC
Q_{rr}	0	nC



Gate	8
Drain	1, 2, 3, 4
Kelvin Source	7
Source	5, 6, 9

Table 2 Ordering Information

Type/Ordering Code	Package	Marking
CID9N65	DFN 5x6, 2500 pcs/reel	9N65

1 Maximum ratings

at $T_j = 25^\circ\text{C}$ unless otherwise specified. Continuous application of maximum ratings can deteriorate transistor lifetime.
For further information, contact Tokmas sales office.

Table 3 Maximum rating

Parameters	Symbols	Values			Units	Notes/Test Conditions
		Min.	Typ.	Max.		
Drain-source voltage	$V_{DS, \text{max}}$	-	-	650	V	$V_{GS} = 0 \text{ V}$, $I_D = 10 \mu\text{A}$
Drain-source voltage transient ¹	$V_{DS, \text{transient}}$	-	-	750	V	$V_{GS} = 0 \text{ V}$, $V_{DS} = 750 \text{ V}$
Continuous current, drain-source	I_D	-	-	4.8	A	$T_c = 25^\circ\text{C}$
Pulsed current, drain-source ²	$I_{D, \text{pulse}}$	-	-	9	A	$T_c = 25^\circ\text{C}$; $V_G = 6 \text{ V}$
Pulsed current, drain-source ²	$I_{D, \text{pulse}}$	-	-	6	A	$T_c = 125^\circ\text{C}$; $V_G = 6 \text{ V}$
Gate-source voltage, continuous ³	V_{GS}	-1.4	-	+7	V	$T_j = -55^\circ\text{C}$ to 150°C
Gate-source voltage, pulsed	$V_{GS, \text{pulse}}$	-	-	+10	V	$T_j = -55^\circ\text{C}$ to 150°C ; $t_{\text{pulse}} = 50 \text{ ns}$, $f = 100 \text{ kHz}$; open drain
Power dissipation	P_{tot}	-	-	39	W	$T_c = 25^\circ\text{C}$
Operating temperature	T_j	-55	-	+150	°C	
Storage temperature	T_{stg}	-55	-	+150	°C	

1. $V_{DS, \text{transient}}$ is intended for surge rating during non-repetitive events, $t_{\text{pulse}} < 1 \mu\text{s}$.

2. Pulse width = 10 μs .

3. The minimum V_{GS} is clamped by ESD protection circuit, as shown in Figure 8.

2 Thermal characteristics

Table 4 Thermal characteristics

Parameters	Symbols	Values			Units	Notes/Test Conditions
		Min.	Typ.	Max.		
Thermal resistance, junction-case	R_{thJC}	-	-	3.2	°C/W	
Reflow soldering temperature	T_{sold}	-	-	260	°C	MSL3

3 Electrical characteristics

at $T_j = 25^\circ\text{C}$, unless specified otherwise.

Table 5 Static characteristics

Parameters	Symbols	Values			Units	Notes/Test Conditions
		Min.	Typ.	Max.		
Gate threshold voltage	$V_{GS(TH)}$	1.2	1.5	2.2	V	$I_D = 5.2 \text{ mA}; V_{DS} = V_{GS}; T_j = 25^\circ\text{C}$
		-	1.5	-		$I_D = 5.2 \text{ mA}; V_{DS} = V_{GS}; T_j = 125^\circ\text{C}$
Drain-source leakage current	I_{DSS}	-	-	10	μA	$V_{DS} = 650 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25^\circ\text{C}$
		-	-	50		$V_{DS} = 650 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125^\circ\text{C}$
Gate-source leakage current	I_{GSS}	-	-	200	μA	$V_{GS} = 6 \text{ V}; V_{DS} = 0 \text{ V}$
Drain-source on-state resistance	$R_{DS(on)}$	-	334	480	$\text{m}\Omega$	$V_{GS} = 6 \text{ V}; I_D = 2 \text{ A}; T_j = 25^\circ\text{C}$
		-	584	-	$\text{m}\Omega$	$V_{GS} = 6 \text{ V}; I_D = 2 \text{ A}; T_j = 125^\circ\text{C}$
Gate resistance	R_G	-	6	-	Ω	$f = 5 \text{ MHz}; \text{open drain}$

Table 6 Dynamic characteristics

Parameters	Symbols	Values			Units	Notes/Test Conditions
		Min.	Typ.	Max.		
Input capacitance	C_{iss}	-	42	-	pF	$V_{GS} = 0 \text{ V}; V_{DS} = 400 \text{ V}; f = 100 \text{ kHz}$
Output capacitance	C_{oss}	-	13	-	pF	$V_{GS} = 0 \text{ V}; V_{DS} = 400 \text{ V}; f = 100 \text{ kHz}$
Reverse transfer capacitance	C_{rss}	-	0.3	-	pF	$V_{GS} = 0 \text{ V}; V_{DS} = 400 \text{ V}; f = 100 \text{ kHz}$
Effective output capacitance, energy related ¹	$C_{o(er)}$	-	16	-	pF	$V_{GS} = 0 \text{ V}; V_{DS} = 0 \text{ to } 400 \text{ V}$
Effective output capacitance, time related ²	$C_{o(tr)}$	-	24	-	pF	$V_{GS} = 0 \text{ V}; V_{DS} = 0 \text{ to } 400 \text{ V}$
Output charge	Q_{oss}	-	9.9	-	nC	$V_{GS} = 0 \text{ V}; V_{DS} = 0 \text{ to } 400 \text{ V}$
Turn-on delay time	$t_{d(on)}$	-	12	-	ns	$V_{DS} = 400 \text{ V}; I_D = 4 \text{ A}; L = 470 \mu\text{H};$ $V_{GS} = 6 \text{ V}; R_{on} = 10 \Omega; R_{off} = 2 \Omega$
Turn-off delay time	$t_{d(off)}$	-	12	-	ns	
Rise time	t_r	-	4	-	ns	
Fall time	t_f	-	20	-	ns	

1. $C_{o(er)}$ is the fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400 V.

2. $C_{o(tr)}$ is the fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400 V.

Table 7 Gate charge characteristics

Parameters	Symbols	Values			Units	Notes/Test Conditions
		Min.	Typ.	Max.		
Gate charge	Q_G	-	1.2	-	nC	
Gate-source charge	Q_{GS}	-	0.1	-	nC	$V_{GS} = 0$ to 6 V; $V_{DS} = 400$ V;
Gate-drain charge	Q_{GD}	-	0.5	-	nC	$I_D = 2$ A
Gate plateau voltage	V_{plat}	-	2.7	-	V	$V_{DS} = 400$ V; $I_D = 2$ A

Table 8 Reverse conduction characteristics

Parameters	Symbols	Values			Units	Notes/Test Conditions
		Min.	Typ.	Max.		
Source-drain reverse voltage	V_{SD}	-	3	-	V	$V_{GS} = 0$ V; $I_{SD} = 2$ A
Pulsed current, reverse	$I_{S, pulse}$	-	10	-	A	$V_{GS} = 6$ V
Reverse recovery charge	Q_{rr}	-	0	-	nC	$I_{SD} = 2$ A; $V_{DS} = 400$ V
Reverse recovery time	t_{rr}	-	0	-	ns	
Peak reverse recovery current	I_{rrm}	-	0	-	A	

4 Electrical characteristics diagrams

at $T_j = 25^\circ\text{C}$, unless specified otherwise.

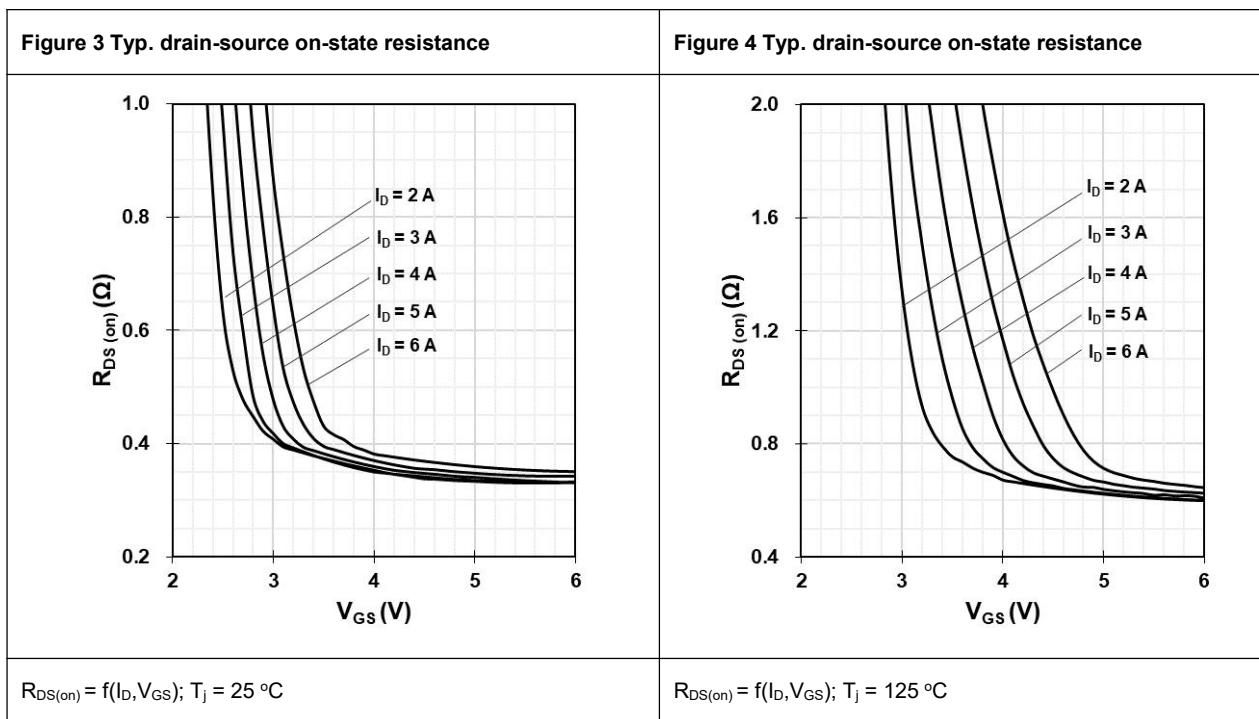
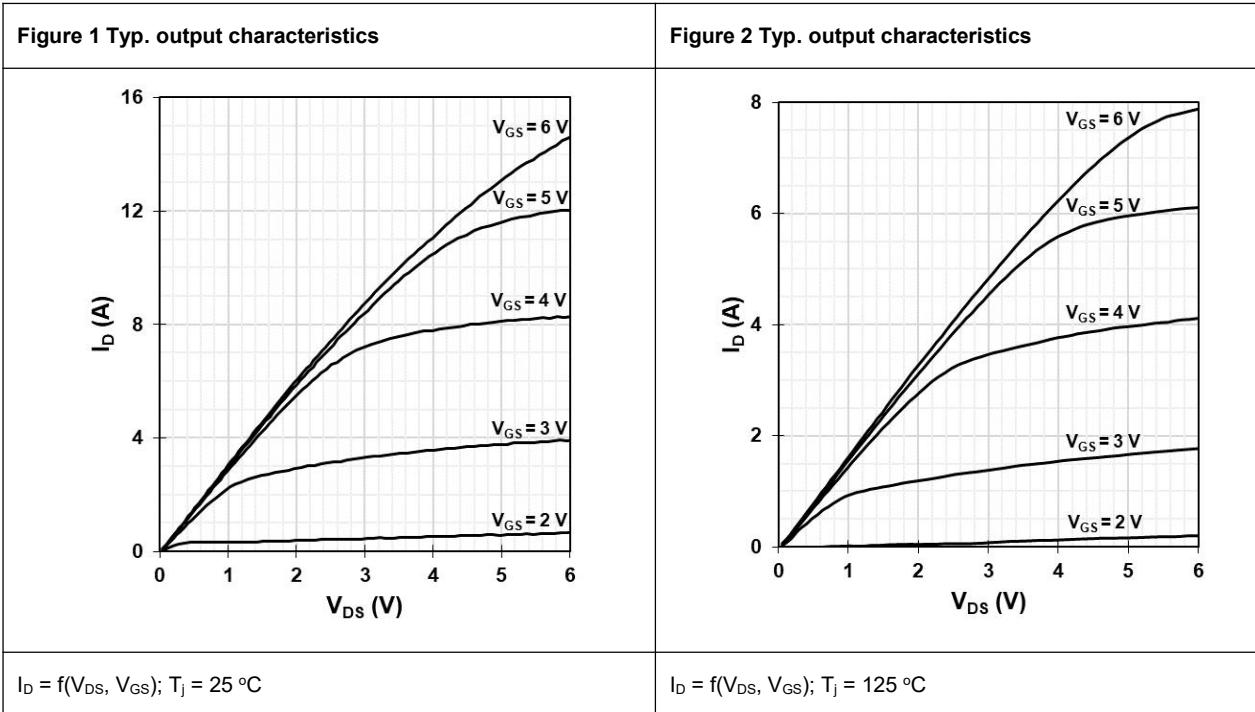
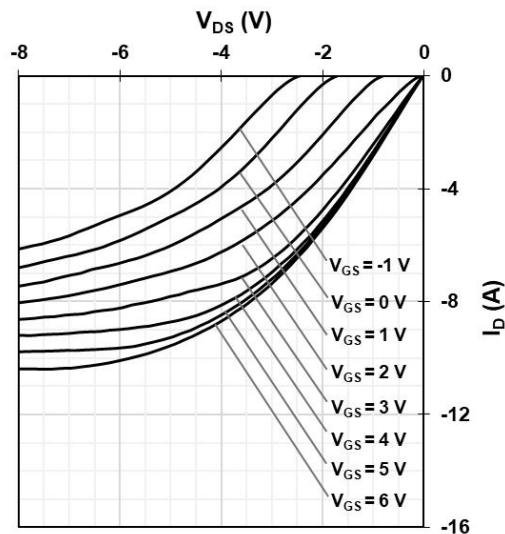
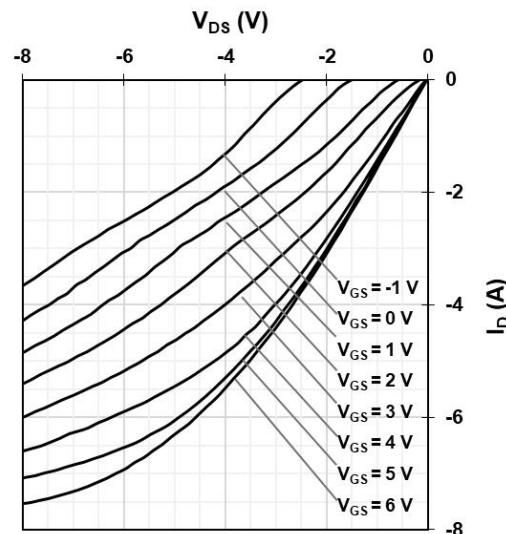
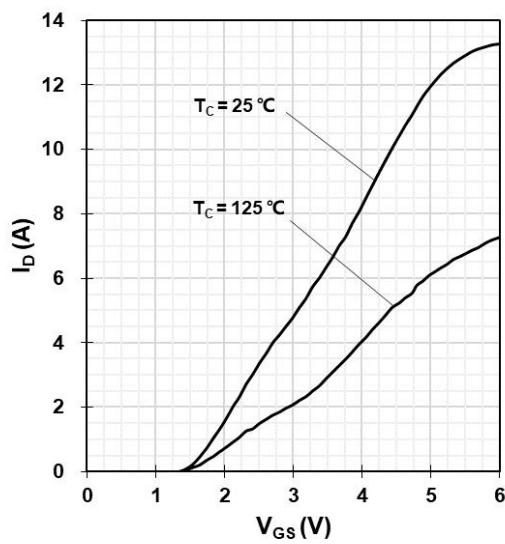
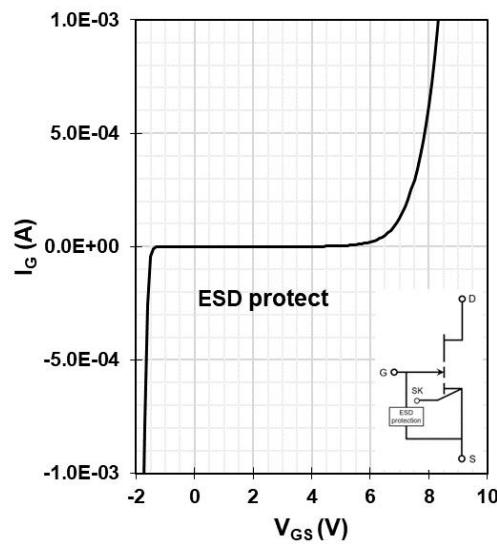


Figure 5 Typ. channel reverse characteristics

Figure 6 Typ. channel reverse characteristics

 $I_D = f(V_{DS}, V_{GS})$; $T_j = 25^\circ\text{C}$
 $I_D = f(V_{DS}, V_{GS})$; $T_j = 125^\circ\text{C}$
Figure 7 Typ. transfer characteristics

Figure 8 Typ. gate-to-source leakage

 $I_D = f(V_{GS})$; $V_{DS} = 5$ V

 $I_G = f(V_{GS})$; I_G reverse turn on by ESD unit; $V_D = \text{open}$

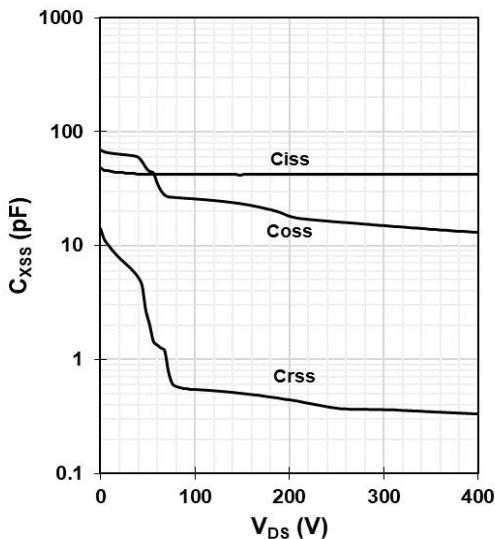
Figure 9 Typ. capacitances

 $C_{XSS} = f(V_{DS})$; Freq. = 100 kHz

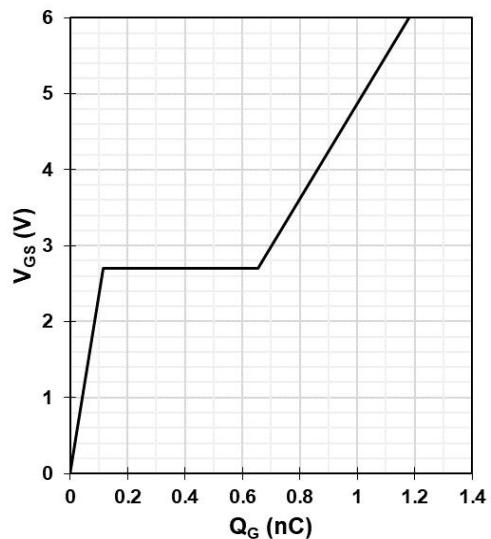
Figure 10 Typ. gate charge

 $V_{GS} = f(Q_G)$; $V_{DS} = 400$ V; $I_D = 2$ A

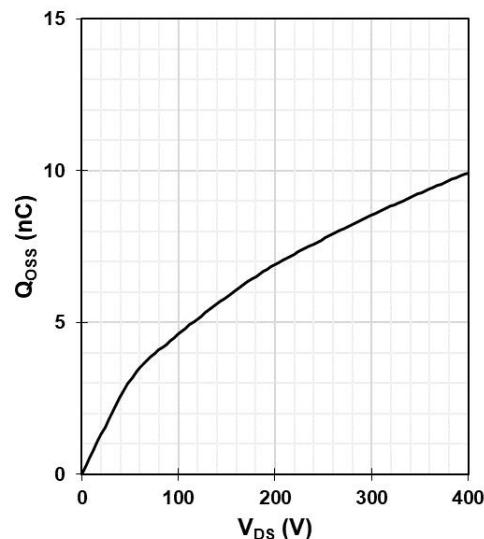
Figure 11 Typ. output charge

 $Q_{oss} = f(V_{DS})$; Freq. = 100 kHz

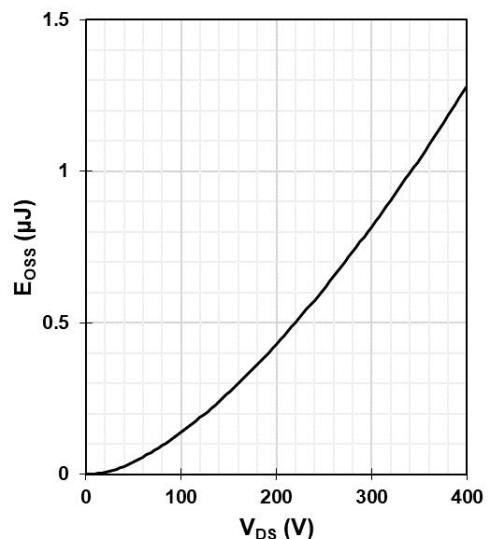
Figure 12 Typ. C_{oss} stored energy

 $E_{oss} = f(V_{DS})$; Freq. = 100 kHz

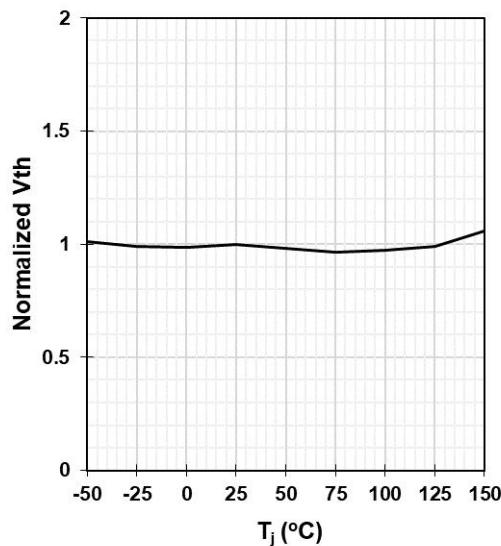
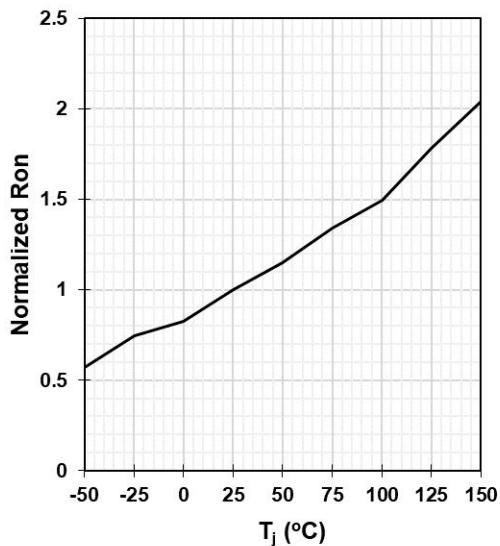
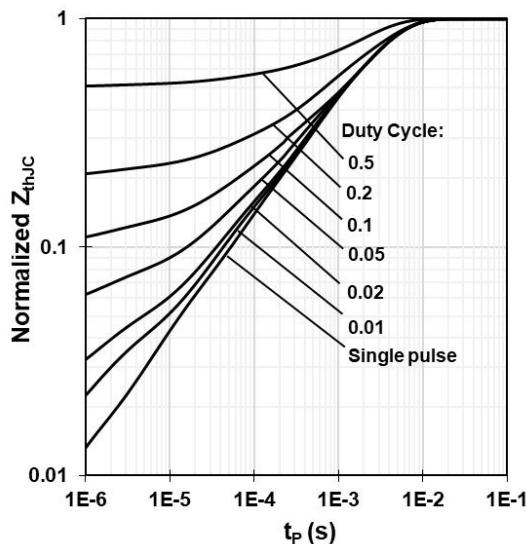
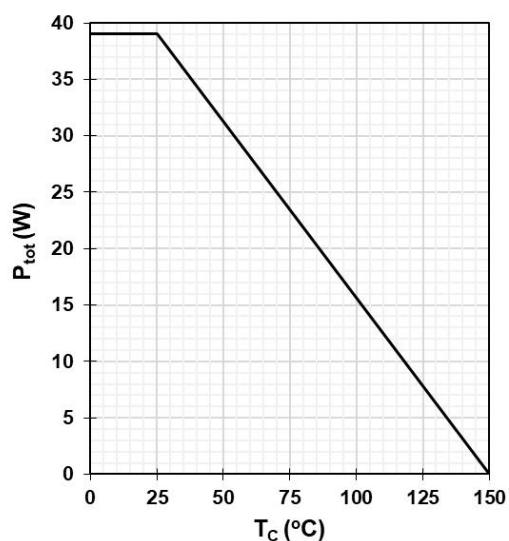
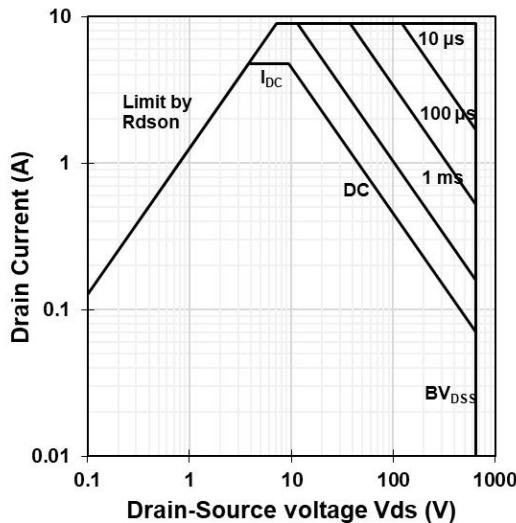
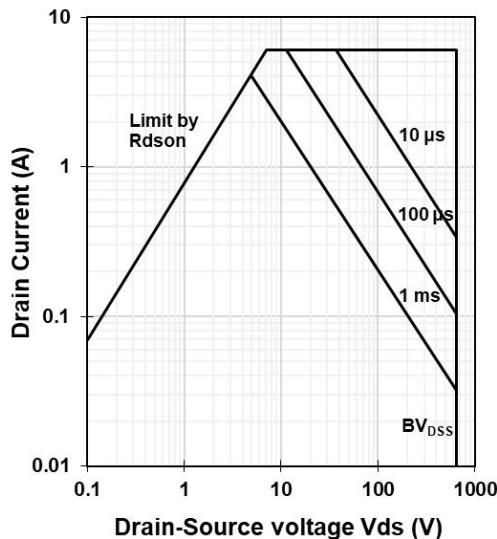
Figure 13 Gate threshold voltage

 $V_{GS(TH)} = f(T_j); V_{GS} = V_{DS}; I_D = 5.2 \text{ mA}$
Figure 14 Drain-source on-state resistance

 $R_{DS(on)} = f(T_j); I_D = 2 \text{ A}; V_{GS} = 6 \text{ V}$
Figure 15 Max. transient thermal impedance

 $Z_{thJC} = f(t_p, D)$
Figure 16 Power dissipation

 $P_{tot} = f(T_c)$

Figure 17 Safe operating area



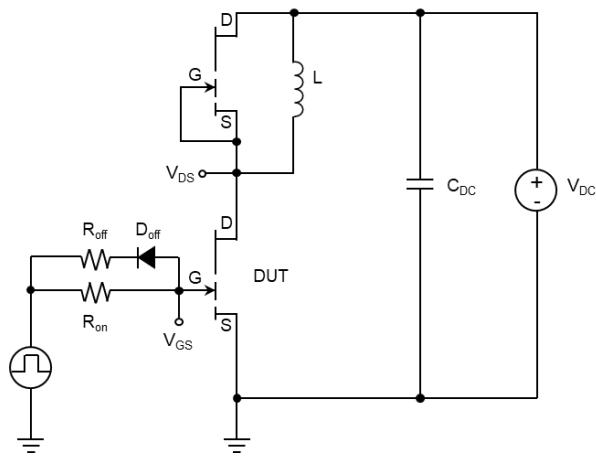
$I_D = f(V_{DS})$; $T_C = 25^\circ C$

Figure 18 Safe operating area



$I_D = f(V_{DS})$; $T_C = 125^\circ C$

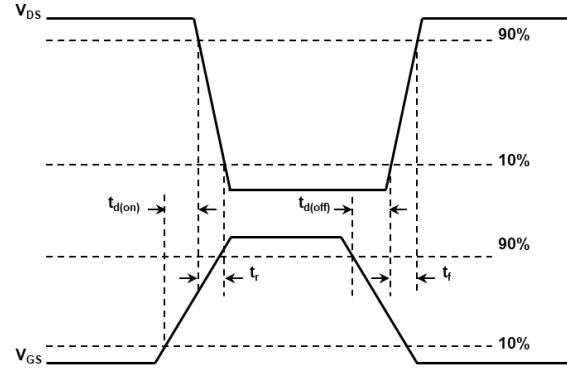
Figure 19 Switching times test circuit



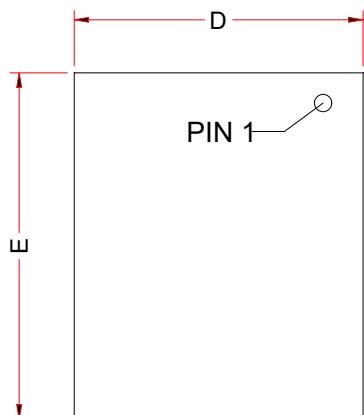
$V_{DS} = 400 V$, $I_D = 4 A$, $L = 470 \mu H$, $V_{GS} = 6 V$,

$R_{on} = 10 \Omega$, $R_{off} = 2 \Omega$

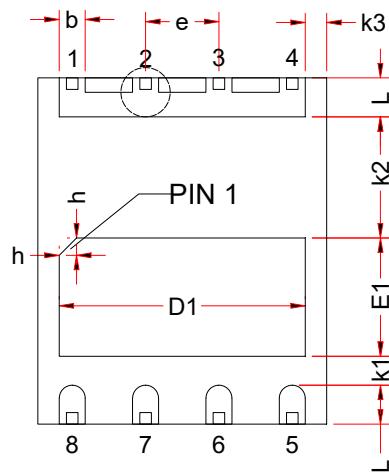
Figure 20 Typ. switching times waveform



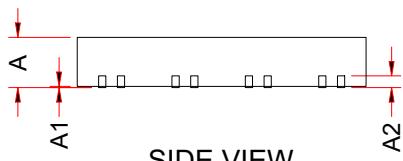
5 Package outlines



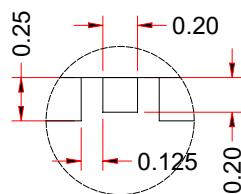
TOP VIEW



BOTTOM VIEW



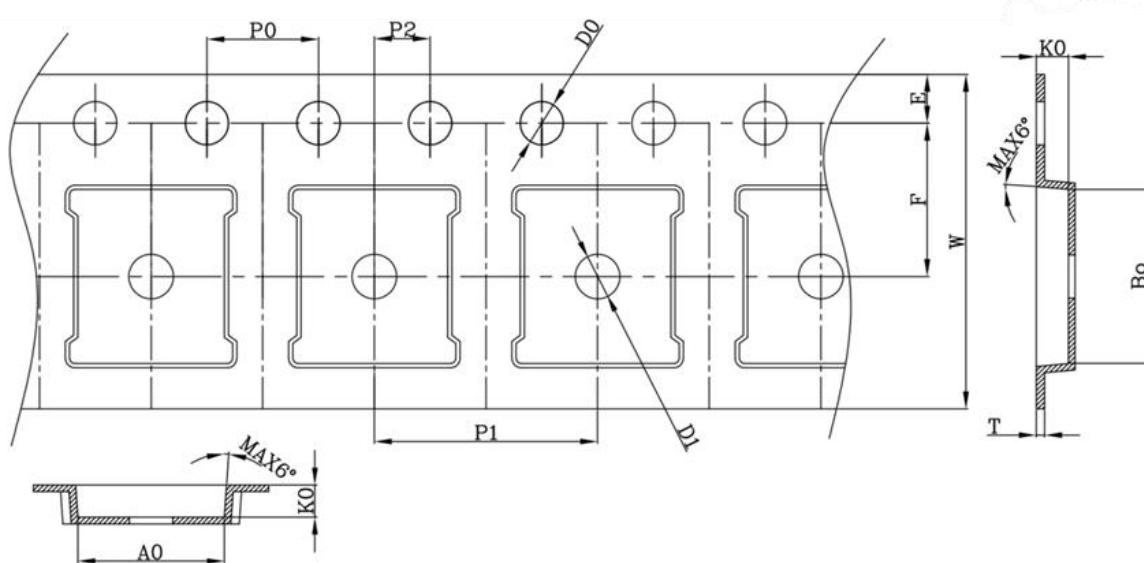
SIDE VIEW



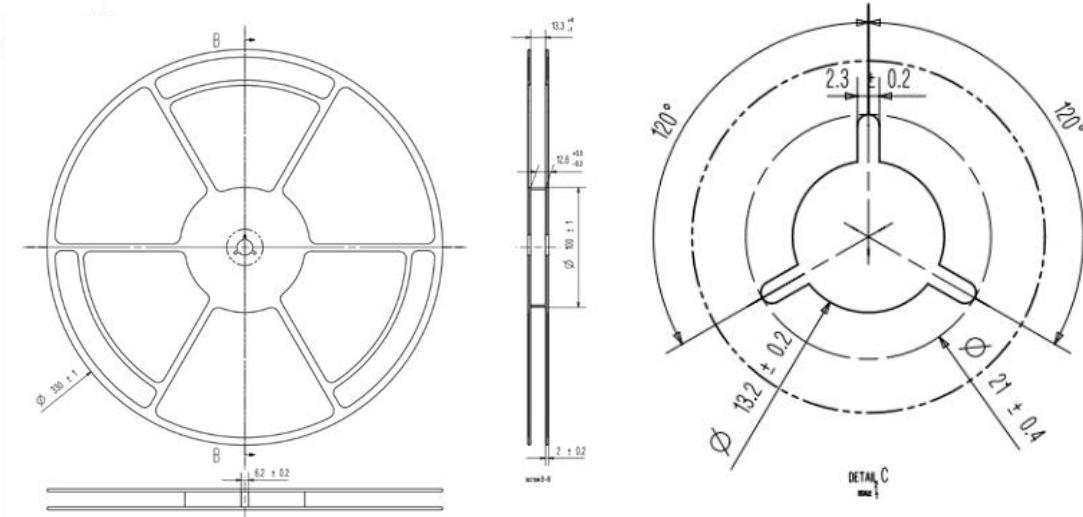
LEAD DETAIL

	MIN	MID	MAX
A	0.75	0.85	0.95
A1	0.00	0.02	0.05
A2			0.203REF
b	0.40	0.45	0.50
D	4.90	5.00	5.10
D1	4.16	4.26	4.36
E	5.90	6.00	6.10
E1	1.95	2.05	2.15
h	0.20	0.30	0.40
L	0.575	0.675	0.775
e	1.270BSC		
k1	0.400MIN		
k2	2.000MIN		
k3	0.270MIN		

6 Reel information



SYMBOL	DIMENSION	SYMBOL	DIMENSION
W	12.00±0.30	10P0	40.00±0.20
E	1.75±0.10	P1	8.00±0.10
F	5.50±0.05	A0	5.25±0.10
D0	1.55±0.05	B0	6.25±0.10
D1	1.55±0.10	K0	1.15±0.10
P0	4.00±0.10	T	0.25±0.05
P2	2.00±0.05		



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